



INTERNATIONAL
GEMOLOGICAL
INSTITUTE

ELECTRONIC COPY

LABORATORY GROWN DIAMOND REPORT

August 3, 2026

IGI Report Number

Description

Shape and Cutting Style

Measurements

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

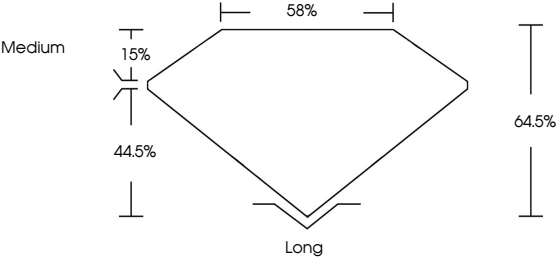
Inscription(s)

Comments: This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Indications of post-growth treatment.

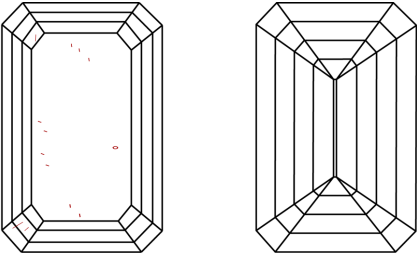
LG821684324

Report verification at igi.org

PROPORTIONS



CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics.
Green symbols indicate external characteristics.

COLOR

D	E	F	G	H	I	J	Faint	Very Light	Light
---	---	---	---	---	---	---	-------	------------	-------

CLARITY

FL	IF	VVS ¹⁻²	VS ¹⁻²	SI ¹⁻²	I ¹⁻³
Flawless	Internally Flawless	Very Very Slightly Included	Very Slightly Included	Slightly Included	Included

Sample Image Used



LABORATORY GROWN DIAMOND REPORT



August 3, 2026

IGI Report Number

Description

Shape and Cutting Style

Measurements

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

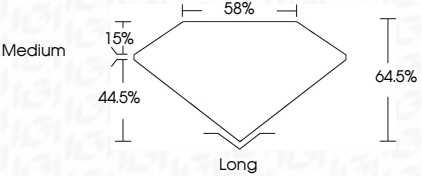
Inscription(s)

Comments: This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Indications of post-growth treatment.

LG821684324

Report verification at igi.org

PROPORTIONS



IGI



August 3, 2026

IGI Report No LG821684324

EMERALD CUT

2.02 CARATS

FANCY INTENSE PINK

VS 2

64.5%

58%

Medium

Long

EXCELLENT

EXCELLENT

SLIGHT

IGI LG821684324

Comments: This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Indications of post-growth treatment.



© IGI 2020, International Gemological Institute

FD - 10 20



THIS DOCUMENT WAS PRODUCED WITH THE FOLLOWING SECURITY MEASURES: SPECIAL DOCUMENT PAPER, INK SCREENS, WATERMARK BACKGROUND DESIGNS, HOLOGRAM AND OTHER SECURITY FEATURES NOT LISTED AND DO EXCEED DOCUMENT SECURITY INDUSTRY GUIDELINES.